

Microsemi Corporation

July 2017

Final Product/Process Change Notification No: PCN 2017-016

Change Classification: Major

Subject: Assembly Transfer of Powermite[™] Line – Powermite 3 Package

Description of Change: Please note that Microsemi Semiconductors Manila - Philippines, Inc. located at FTI Special Economic Zone, Electronics Avenue, Taguig, Philippines (or MSP-T) will transfer the manufacturing of the Powermite™ line to Fastech Advanced Assembly Inc., located at Fastech Manufacturing Complex, Ampere Street cor. West Road, Light Industry and Science Park I, Cabuyao, Laguna, Philippines 4025.

Reason for Change: Consolidation of product line assembly as part of Microsemi's ongoing initiative driving operational and service efficiencies.

Application Impact:

As a Microsemi assembly subcontractor, Fastech will manufacture products using the existing manufacturing flows, equipment, materials, process controls and monitors, therefore ensuring the same level of quality and reliability. There will be no change to form, fit or function of the product.

Method of Identifying Changed Product:

The parts that will be assembled will be identified by assembly lot and date code.

Products Affected by this Change:

See Appendix

Note: This is a list of Ordering Part Numbers (OPNs) as are found in product datasheets. Customers may track additional part number variants in their systems, so please consider this a base part list.

Production Shipment Schedule:

Product with the change is planned to ship no sooner than July 2017.

During a transition period, customers may see shipments with either location while any existing inventory of parts is depleted.

Qualification Data:



PMT3 Qualification Data

This document summarizes the qualification testing done on the PMT3 family

Maximum Ratings

Operating Temperatures: -55 °C to +150 °C Storage Temperatures: -55 °C to +150 °C

Datasheets are available at http://www.microsemi.com

	Qualification Data Summary								
Screening Level	Test Performed	Conditions	Duration or Qty	Standard/Ref	Sample size	No. Of Lots	Failures		
М	Temperature Cycle	-55 °C to +150 °C	1000 cycles	MIL-STD-750F Method 1051	77	1	0		
М	HTRB	125 °C	1000 hours	MIL-STD-750F Method 1038	77	1			
М	Autoclave	121 °C, 100 % RH, 15 psig	96 hours	JESD22-A102	77	1	0		
M	Resistance to Solder Heat	-	-	JESD22-B106	30	1	0		
М	Physical Dimensions	-	-	MIL-STD-750F Method 2066	15	1	0		
М	Visual and Mechanical Review	-	-	MIL-STD-750F Method 2071	45	1	0		
M	Pre-conditioning	-	-	JESD22 A-113	-	1	0		
М	Solderability	-	-	J-STD-002 JESD22B102	10	1	0		
М	DPA	-	-	AEC-Q101-004 Section 4	2	1			
M	MSL	-	-	J-STD-02D-01	22	1	0		
М	Bond Shear	-	-	MIL-STD-750 Method 2017	5	1	0		

Samples Availability:

Please contact your local Microsemi representative to place sample orders.



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Regards,

Microsemi Corporation

Any projected dates in this PCN are based on the most current product information at the time this PCN is being issued, but they may change due to unforeseen circumstances. For the latest schedule and any other information, please contact your local Microsemi Sales Office, the factory contact shown above, or your local distributor.

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<To be attached only where customer acknowledgement/approval is necessary prior to implementation>

CHANGE APPROVAL SUPPLEMENT

Customer Acknowledgement / Approval

Product/Process Change Notification No: PCN 2017-016

Microsemi Corporation intends to implement this change 90 days after this notification. Acknowledgement of your company's acceptance of this change is requested per contractual agreement. Response within 30 days is required.

Accepted	Rejected	
Signature	Date	
Name	Title	
Please enter rationale for	rejection, if applicable:	



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Appendix

MSC part number	<u>Device type</u>	<u>Description</u>	<u>Package</u>	Reel Size
UPGA301A/TR13	SCR	ITSM = 100A, VDRM = 100V, IGT < 200uA	Powermite 3	13"
UPGA301Ae3/TR13	SCR	ITSM = 100A, VDRM = 100V, IGT < 200uA	Powermite 3	13"
UPS10100/TR13	Schottky	10.0A, 100V, VF=0.72V	Powermite 3	13"
UPS10100e3/TR13	Schottky	10.0A, 100V, VF=0.72V	Powermite 3	13"
UPS1040/TR13	Schottky	10.0A, 40V, VF=0.47V	Powermite 3	13"
UPS1040e3/TR13	Schottky	10.0A, 40V, VF=0.47V	Powermite 3	13"
UPS3100/TR13	Schottky	3.0A, 100V, VF=0.64V	Powermite 3	13"
UPS3100e3/TR13	Schottky	3.0A, 100V, VF=0.64V	Powermite 3	13"
UPS315/TR13	Schottky	3.0A, 15V, VF=0.22V	Powermite 3	13"
UPS315e3/TR13	Schottky	3.0A, 15V, VF=0.22V	Powermite 3	13"
UPS3200/TR13	Schottky	3.0A, 200V, VF=0.78V	Powermite 3	13"
UPS3200e3/TR13	Schottky	3.0A, 200V, VF=0.78V	Powermite 3	13"
UPS340/TR13	Schottky	3.0A, 40V, VF=0.44V	Powermite 3	13"
UPS340e3/TR13	Schottky	3.0A, 40V, VF=0.44V	Powermite 3	13"
UPS360/TR13	Schottky	3.0A, 60V, VF=0.57V	Powermite 3	13"
UPS360e3/TR13	Schottky	3.0A, 60V, VF=0.57V	Powermite 3	13"
UPS5100/TR13	Schottky	5.0A, 100V, VF=0.64V	Powermite 3	13"
UPS5100e3/TR13	Schottky	5.0A, 100V, VF=0.64V	Powermite 3	13"
UPS540/TR13	Schottky	5.0A, 40V, VF=0.45V	Powermite 3	13"
UPS540e3/TR13	Schottky	5.0A, 40V, VF=0.45V	Powermite 3	13"
UPS560/TR13	Schottky	5.0A, 60V, VF=0.60V	Powermite 3	13"
UPS560e3/TR13	Schottky	5.0A, 60V, VF=0.60V	Powermite 3	13"
UPS615/TR13	Schottky	6.0A, 15V, VF=0.22V	Powermite 3	13"
UPS6150/TR13	Schottky	6.0A, 150V, VF=0.65V	Powermite 3	13"
UPS6150e3/TR13	Schottky	6.0A, 150V, VF=0.65V	Powermite 3	13"
UPS615e3/TR13	Schottky	6.0A, 15V, VF=0.22V	Powermite 3	13"
UPS760/TR13	Schottky	7.0A, 60V, VF=0.48V	Powermite 3	13"
UPS760e3/TR13	Schottky	7.0A, 60V, VF=0.48V	Powermite 3	13"
UPS835L/TR13	Schottky	8.0A, 35V, VF=0.41V	Powermite 3	13"
UPS835Le3/TR13	Schottky	8.0A, 35V, VF=0.41V	Powermite 3	13"
UPS840/TR13	Schottky	8.0A, 40V, VF=0.42V	Powermite 3	13"
UPS840e3/TR13	Schottky	8.0A, 40V, VF=0.42V	Powermite 3	13"